

**BFQ19****CASE 345-01, STYLE 1**  
**SOT-89****RF TRANSISTOR**

NPN SILICON

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	15	V
Collector-Base Voltage	$V_{CBO}$	20	V
Emitter-Base Voltage	$V_{EBO}$	3.0	V
Collector Current Max ( $f > 1.0$ MHz)	$I_{CM}$	150	mA
Collector Current — Average	$I_{CAV}$	75	mA
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-55 to +150	°C

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
*Total Device Dissipation, $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	1.0 8.0	Watt mW/°C
Storage Temperature	$T_{stg}$	150	°C
*Thermal Resistance Junction to Ambient	$R_{\theta JA}$	125	°C/W

\*Package mounted on 99.5% alumina 10 x 12 x 0.6 mm.

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector-Emitter Breakdown Voltage ( $I_C = 10$ mA)	$V_{(BR)CEO}$	15	—	V
Collector-Base Breakdown Voltage ( $I_C = 10$ $\mu\text{A}$ )	$V_{(BR)CBO}$	20	—	V
Emitter-Base Breakdown Voltage ( $I_E = 10$ $\mu\text{A}$ )	$V_{(BR)EBO}$	3.0	—	V
Collector Cutoff Current ( $V_{CB} = 10$ V)	$I_{CBO}$	—	100	nA
Emitter Cutoff Current ( $V_{EB} = 1.0$ V)	$I_{EBO}$	—	100	nA
<b>ON CHARACTERISTICS</b>				
DC Current Gain ( $I_C = 50$ mA, $V_{CE} = 10$ V) ( $I_C = 75$ mA, $V_{CE} = 10$ V)	$h_{FE}$	25 25	— —	—
<b>SMALL-SIGNAL CHARACTERISTICS</b>				
Current-Gain — Bandwidth Product ( $I_C = 50$ mA, $V_{CE} = 10$ V, $f = 500$ MHz) ( $I_C = 75$ mA, $V_{CE} = 10$ V, $f = 500$ MHz)	$f_T$	4.0 4.4	— —	GHz
Collector-Base Capacitance ( $V_{CB} = 10$ V, $f = 1.0$ MHz)	$C_{cb}$	—	1.6	pF
Capacitance Emitter-to-Base ( $V_{EB} = 0.5$ V, $f = 1.0$ MHz)	$C_{eb}$	—	5.0	pF
Reverse Transfer Capacitance Common Emitter ( $V_{CE} = 10$ V, $I_C = 10$ mA, $f = 1.0$ MHz)	$C_{re}$	—	1.3	pF
Noise Figure ( $I_C = 50$ mA, $V_{CE} = 10$ V, $f = 500$ MHz)	NF	—	3.3	dB